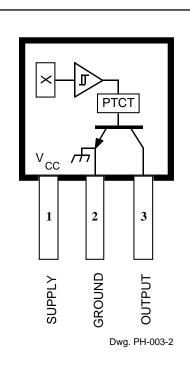
(subject to change without notice)
April 23, 2002

Ortice) PROGRAMMABLE, CHOPPER-STABILIZED, HALL-EFFECT SWITCHES



ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V _{CC} 26.5 V*
Reverse Supply Voltage, V _{RCC} 18 V
Overvoltage Supply Current, I _{CC} 100 mA
Output Off Voltage, V _{OUT} 26.5 V
Continuous Output Current, I _{OUT} 20 mA†
Magnetic Flux Density, B Unlimited
Package Power Dissipation, P _D See Graph
Operating Temperature Range, T _A
Suffix 'J-'40°C to +115°C
Suffix 'L-'40°C to +150°C
Junction Temperature, T _J +165°C
Storage Temperature Range,

* Fault conditions that produce supply voltage transients will be clamped by an internal Zener diode. These conditions can be tolerated but should be avoided.

 T_S -65°C to +170°C

† Internal current limiting is intended to protect the device from output short circuits. The A3250 and A3251 are programmable switches that provide tooth/valley recognition in large gear-tooth sensing, high-temperature applications. Each sensor consists of a single element, chopper-stabilized Hall-effect IC that can be programmed to the desired magnetic operate switch point (drastically reducing the effects of variations found in a production environment), while the hysteresis remains fixed. The small package can be easily assembled and used in conjunction with a wide variety of gear/target shapes and sizes. The A3250 output turns on in the presence of the programmed south-pole magnetic field while the A3251 turns off with the programmed south-pole magnetic field.

These sensor systems are ideal for use in gathering speed, position, and timing information using gear-tooth-based configurations. They are particularly suited to those applications that require accurate duty cycle control or accurate edge detection. The lower vibration sensitivity also makes these devices extremely useful for transmission speed sensing.

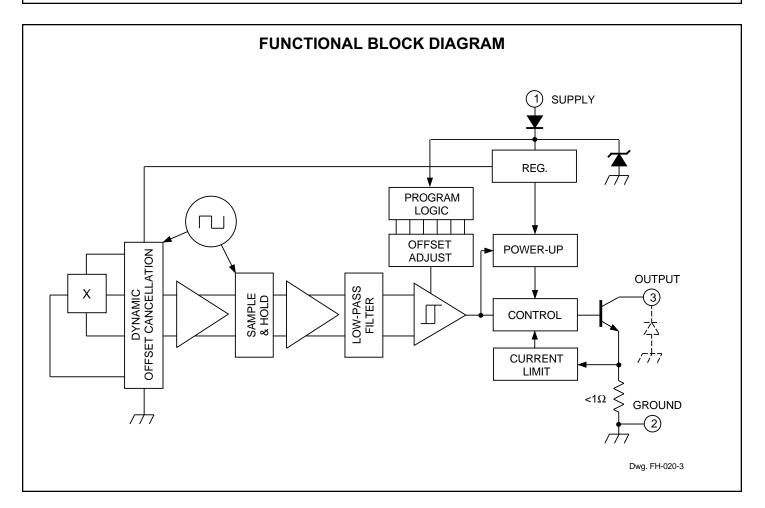
The first character of the part number suffix determines the device operating temperature range. Suffix 'J–' is for the automotive and industrial temperature range of -40°C to +115°C. Suffix 'L–' is for the automotive and military temperature range of -40°C to +150°C. The package is a three-lead ultra-mini-SIP for through-hole mounting (suffix '–UA'). It is also available with lead forming for surface-mount applications (suffix '–UA-TL').

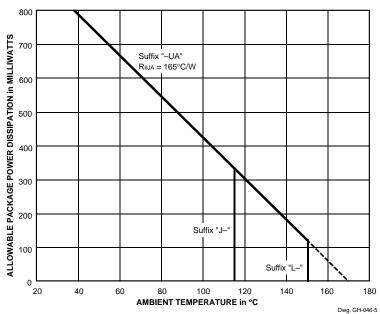
FEATURES AND BENEFITS

- Chopper Stabilized for Extremely Low Switch-Point Drift and Immunity to Mechanical Stress
- Externally Programmed Switch Point
- On-Chip Supply-Transient Protection
- Output Short-Circuit Protection
- Reverse Battery Protection
- Wide Operating Voltage Range
- Defined Power-On State

Always order by complete part number: the prefix 'A' + the basic four-digit part number + a suffix to indicate operating temperature range ('J' or 'L') + a suffix to indicate package style ('UA'), e.g., [A3250LUA].







ELECTRICAL CHARACTERISTICS over operating voltage and junction temperature range (unless otherwise noted).

			Limits			
Characteristic	Symbol	Test Conditions		Тур.	Max.	Units
Supply Voltage	V _{CC}	Operating	4.2	-	24	V
Power-On State	POS	After programming, $V_{CC} = 0 \rightarrow 5 \text{ V}$, $t > t_{on}$: A3250, B < B _{OP} A3251, B < B _{OP}		HIGH LOW	HIGH LOW	_ _
Low Output Voltage	V _{OUT(SAT)}	Output on, I _{OUT} = 20 mA	_	175	400	mV
Output Current Limit	I _{OUTM}	Pulse test, output on	35	70	100	mA
Output Leakage Current	I _{OFF}	Output off, V _{OUT} = 24 V	-	-	10	μΑ
Supply Current	I _{cc}	Output off (High)	-	4.0	7.0	mA
		Output on (Low)	-	6.0	10	mA
Reverse Supply Current	I _{RCC}	V _{RCC} = -18 V	-	-	-5.0	mA
Power-On Delay	t _{on}	Output off	-	20	50	μs
Output Rise Time	t _r	$R_L = 820 \Omega, C_L = 10 pF$	-	-	5.0	μs
Output Fall Time	t _f	$R_L = 820 \Omega, C_L = 10 pF$	-	-	5.0	μs
Clock Frequency	f _C		-	340	=	kHz
Zener Voltage	V _Z	I _{ZT} = 100 μA	27	32	37	V
Zener Resistance	R_{z}	I _{ZT} = 10 mA	_	50	_	Ω

NOTE: Typical data is at V_{CC} = 12 V and T_A = +25°C and is for design information only.

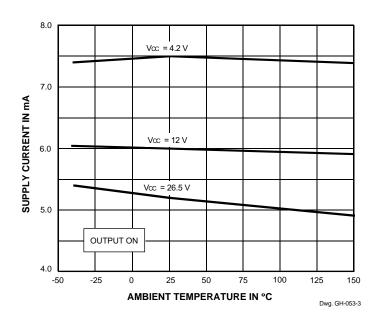
MAGNETIC CHARACTERISTICS over operating supply voltage and junction temperature range (unless otherwise noted).

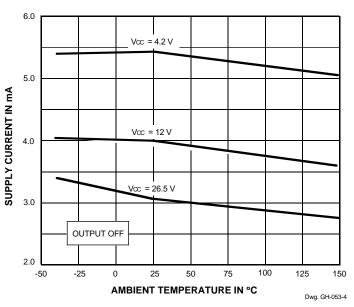
			Limits			
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Operate Point	B _{OP}	Initial (before programming)	-20	13	50	G
(A3250 output turns on)		Resolution	-	7.0	_	G
(A3251 output turns off)		Maximum programmable	350	-	_	G
	ΔB_OP	B _{OP} ≤ 350 G	-	±5.0	±35	G
Hysteresis	B _{hys}	$B_{OP} - B_{RP}$	5.0	18	35	G

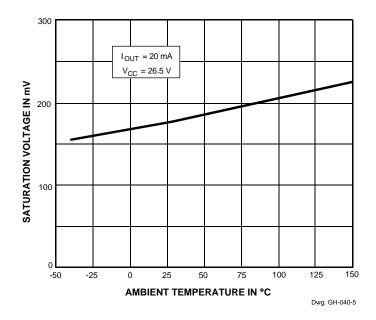
NOTES: 1. Typical data is at $V_{CC} = 12 \text{ V}$ and $T_A = +25^{\circ}\text{C}$ and is for design information only.

^{2. 1} gauss (G) is exactly equal to 0.1 millitesla (mT).

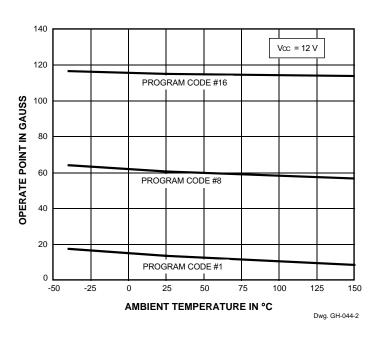
TYPICAL ELECTRICAL CHARACTERISTICS

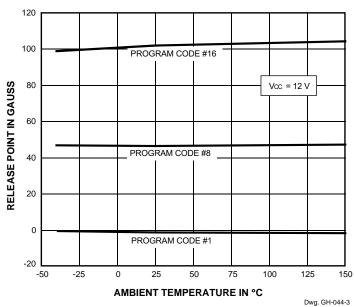


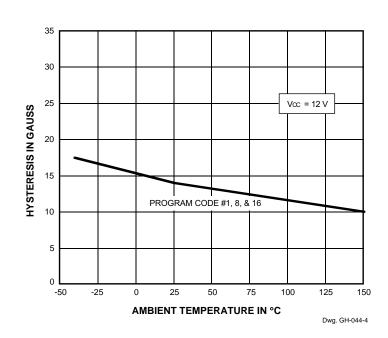




TYPICAL MAGNETIC CHARACTERISTICS







FUNCTIONAL DESCRIPTION

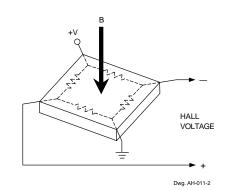
The basic Hall sensor is a small sheet of semiconductor material in which a constant current will flow when a regulated voltage is applied. The output will take the form of a voltage measured across the width of the sheet and will have negligible value in the absence of a magnetic field. When a magnetic field with flux lines at right angles to the current flow is applied, a small voltage directly proportional to the strength of the magnetic field and the current will occur at the output terminals.

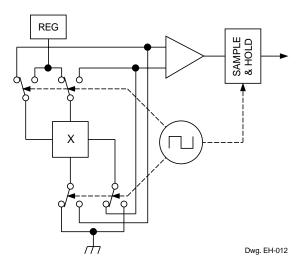
The small signal voltage is proportionally small relative to the offset produced by the semiconductor chip. This makes it very difficult to process the signal and maintain an accurate, reliable output over the operating temperature range.

Chopper-Stabilized Technique. These devices use a proprietary dynamic offset cancellation technique, with an internal high-frequency clock to reduce the residual offset voltage of the Hall element that is normally caused by device overmolding, temperature dependencies, and thermal stress. This technique produces devices that have an extremely stable quiescent Hall output voltage, are immune to thermal stress, and have precise recoverability after temperature cycling. This technique will also slightly degrade the device output repeatability.

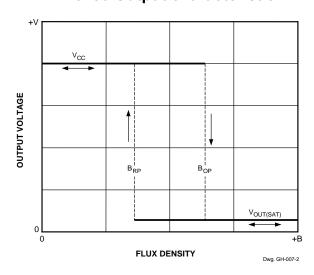
The Hall element can be considered as a resistor array similar to a Wheatstone bridge. A large portion of the offset is a result of the mismatching of these resistors. The chopper-stabilizing technique cancels the mismatching of the resistors by changing the direction of the current flowing through the Hall plate and Hall voltage measurement taps, while maintaining the Hall-voltage signal that is induced by the external magnetic flux. The signal is, then, captured by a sample-and-hold circuit.

Operation. The output of the A3250 switches low (turns on) when a magnetic field (south pole) perpendicular to the Hall sensor exceeds the operate point threshold (B_{OP}). After turn-on, the output is capable of sinking 20 mA and the output voltage is $V_{OUT(SAT)}$. The A3250 operate point is programmable (see next section). When the magnetic field is reduced below the release point (B_{RP}), the device output goes high (turns off).





A3250 Output characteristic





3250 AND 3251 PROGRAMMABLE, CHOPPER-STABILIZED, HALL-EFFECT SWITCHES

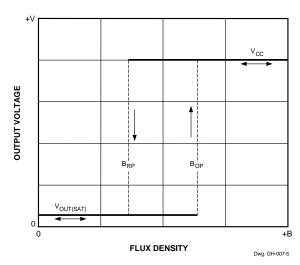
FUNCTIONAL DESCRIPTION (cont'd)

The output of the A3251 switches high (turns off) when a magnetic field (south pole) perpendicular to the Hall sensor exceeds the operate point threshold (B_{OP}). The A3251 operate point is programmable (see next section). When the magnetic field is reduced below the release point (B_{RP}), the device output goes low (turns on). After turnon, the output is capable of sinking 20 mA and the output voltage is $V_{OUT(SAT)}$.

The difference in the magnetic operate and release points is the hysteresis (B_{hys}) of the device. The hysteresis of both devices is identical and independent of the programmed operate point. This built-in hysteresis allows clean switching of the output even in the presence of external mechanical vibration and electrical noise.

Output Overloads. Current through the output transistor is sensed with a low-value on-chip aluminum resistor. The voltage drop across this resistor is fed back to control the base drive of the output stage. This feedback prevents the output transistor from exceeding its maximum current density rating by limiting the output current. Under short-circuit conditions, the device will dissipate an increased amount of power ($P_D = V_{OUT} \times I_{OUTM}$) and the output transistor will be thermally stressed.

A3251 Output characteristic



PROGRAMMING PROTOCOL (at $T_A = +25^{\circ}C$)

The A3250 and A3251 operate points are programmed by serially addressing the device through the supply terminal (pin1). After the correct operate point is determined, the device programming bits are selected and then a "lock" set to prevent any further (accidental) programming.

Programming voltages (V_{PL} , V_{PH} , and V_{PP}) are applied to pin 1 of the device. A minimum capacitance of 0.01 μF must be connected between pin 1 and ground to provide the necessary peak current to blow the internal fuse.

Program Enable. To program the device, a sequence of pulses is used to activate/enable the addressing mode as shown in figure 1. This sequence of a V_{PP} pulse, at least seven V_{PH} pulses, and a V_{PP} pulse with no supply interruptions, is designed to prevent the device from being programmed accidentally (for example, as a result of noise on the supply line).

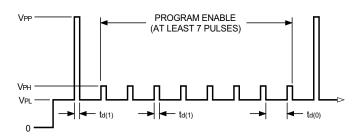


Figure 1 — Program enable

Dwg. WH-013

PROGRAMMING PROTOCOL over operating temperature range.

			Limits			
Characteristic	Symbol	Description	Min.	Тур.	Max.	Units
Programming Voltage	V _{PL}	Minimum voltage during programming	4.5	5.0	5.5	٧
	V _{PH}		10	11	12	٧
	V _{PP}		23	25	26	V
Programming Current	I _{PP}	Max. supply current during programming	_	500	-	mA
Pulse Width	t _{d(0)}	Off time between bits	20	-	-	μs
	t _{d(1)}	Enable, address, program, or lock bit on time	20	_	_	μs
	t _{dP}	Program pulse on time	100	300	_	μs
Pulse Rise Time	t _r	V _{PL} to V _{PH} or V _{PP}	11			μs
Pulse Fall Time	t _f	V _{PH} or V _{PP} to V _{PL}	5.0	_	_	μs

NOTE: Typical data is at $T_A = +25$ °C and is for design information only.



PROGRAMMING PROTOCOL (cont'd)

Addressing. The magnetic operate point is adjustable using 6 bits for 64 increments. With the appropriate target or gear* in position, the 64 switch points are sequentially selected (figure 2) until the required operate point is reached. Note that the difference between the operate point and the release point (hysteresis) is a constant for all addresses.

Address Programming. After the desired switch-point address is determined (0 through 63), each bit of the equivalent binary address is programmed individually (not at the same time). For example, as illustrated in figure 3, to program switch-point address 5 (binary 000101), bits 1 and 3 need to be programmed. Each bit is programmed during the wide $V_{\rm pp}$ pulse and is not reversible.

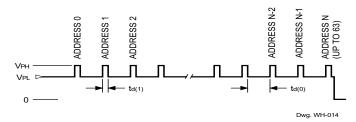


Figure 2 — Address determination

Lock-Bit Programming. After the desired address is programmed, the lock bit (address 65 or bit 7) is then activated (figure 4) to prevent further programming of the device.

Each device should then be tested to ensure that proper programming has been accomplished.

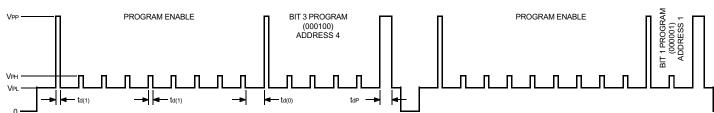
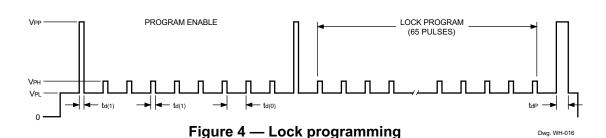


Figure 3 — Switch-point address programming example



^{*} In application, the terms "gear" and "target" are often interchanged. However, "gear" is preferred when motion is transferred.

www.allegromicro.com

Dwg. WH-015

APPLICATIONS INFORMATION

External Components. It is strongly recommended that an external bypass capacitor be connected (less than 5 mm from the Hall sensor) between the supply and ground of the device to reduce both external noise and noise generated by the chopper-stabilization technique.

A series resistor (R_S) in combination with the bypass capacitor prevents external EMC pulses from affecting the sensor. The voltage drop across this resistor subtracts from the supply voltage and must be considered.

$$V_{SUPPLY} \ge V_{CC(min)} + (I_{CC} \times R_S)$$

where V_{SUPPLY} is the minimum supply value (including transients), $V_{CC(min)}$ is the specified minimum supply voltage, I_{CC} is the specified maximum supply current and R_S is the maximum series-resistor value (including tolerances). A low operating supply voltage requires a low-value resistor, but noise and other considerations suggest a high-value resistor. Therefore, specify the highest value resistor that will still allow meeting the minimum operating supply voltage requirement. This will also help to minimize package power dissipation (especially under over-voltage conditions).

If not included as part of the load, the output pullup resistor should be chosen to limit the current through the output transistor. Do not exceed the absolute maximum rated output current. Internal current limiting is only intended to protect the device from output short circuits.

Power Derating. Due to the internal device power dissipation, the junction temperature (T_J) will be higher than the ambient temperature (T_A) . To ensure that the absolute maximum junction temperature is not exceeded, the following equations should be applied:

$$T_{J} = T_{A} + (P_{D} \times R_{\theta JA})$$

where P_D is the sum of the supply power

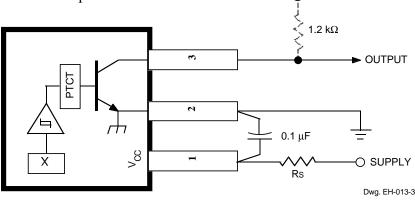
$$I_{CC} \times V_{CC}$$

and the output power

$$I_{OUT} \times V_{OUT(SAT)}$$

and $R_{\theta JA}$ is the package thermal resistance. The specified limits for I_{CC} and $V_{OUT(SAT)}$ should be used to ensure a margin of safety. Note that if an over-voltage condition occurs, I_{CC} will increase, limited only by the Zener voltage and the external R_S , and the device will likely be thermally stressed.

Magnets. The simplest form of magnet that will operate these devices is a ring magnet. Other methods of operation, such as linear magnets, are possible.



Typical application



CRITERIA FOR DEVICE QUALIFICATION

All Allegro sensors are subjected to stringent qualification requirements prior to being released to production. To become qualified, except for the destructive ESD tests, no failures are permitted.

Qualification Test	Test Method and Test Conditions	Test Length	Samples	Comments
Biased Humidity (HAST)	JESD22-A101, T _A = 85°C, RH = 85%	1000 hrs	77	V _{CC} = V _{OUT} = 4.2 V
High-Temperature Operating Life (HTOL)	JESD22-A108, T _A = 150°C, T _J = 165°C	1000 hrs	77	
Accelerated HTOL	JESD22-A108, T _A = 170°C, T _J = 180°C	168 hrs	77	
Autoclave, Unbiased	JESD22-A102, Condition C, $T_A = 121^{\circ}C$, 15 psig	96 hrs	77	
High-Temperature (Bake) Storage Life	MIL-STD-883, Method 1008, T _A = 170°C	1000 hrs	77	
Temperature Cycle	MIL-STD-883, Method 1010, -55°C to +150°C	1000 cycles	77	
ESD, Human Body Model	CDF-AEC-Q100-002	Pre/Post Reading	3 per test	Test to failure, All leads > 1 kV
ESD, Machine Model	JESD22-A115	Pre/Post Reading	3 per test	Test to failure, All leads > TBD
Electrical Distributions	Per Specification	_	30	

APPLICATIONS INFORMATION (cont'd)

Extensive applications information for Hall-effect sensors is available in:

- *Hall-Effect IC Applications Guide*, Application Note 27701;
- Hall-Effect Devices: Soldering, Gluing, Potting, Encapsulating, and Lead Forming, Application Note 27703.1;
- Soldering of Through-Hole Hall-Sensor Dervices, Application Note 27703; and
- *Soldering of Surface-Mount Hall-Sensor Devices*, Application Note 27703.2.

More detailed descriptions of the chopper-stabilized circuit operation can be found in:

- Monolithic Magnetic Hall Sensor Using Dynamic Quadrature Offset Cancelation, Technical Paper STP 97-10; and
- Chopper-Stabilized Amplifiers With A Track-and-Hold Signal Demodulator, Technical Paper STP 99-1.

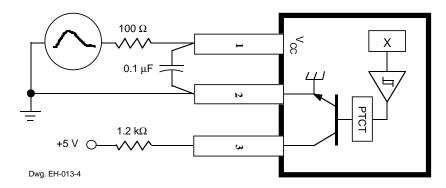
All are provided in *Allegro Electronic Data Book*, AMS-702. or at

www.allegromicro.com

ELECTROMAGNETIC COMPATIBILITY (EMC) REQUIREMENTS

at $T_A = 23 \pm 5^{\circ}C$

ISO		Performance Class at Test Level			
Pulse No.	Test	1	II	III	IV
1	Inductive turn off (negative)	_	-	_	_
2	Inductive turn off (positive)	_	-		_
3a	Capacitive/inductive coupling (neg)	_	-		_
3b	Capacitive/inductive coupling (pos)	_	- (_
4	Reverse battery	_)	_
5	Load dump:	-		_	_
6	Ignition coil disconnect EXTERNAL PROTECTION REQ'D	_	_	-	-
7	Field decay (negative)	_	_	_	_

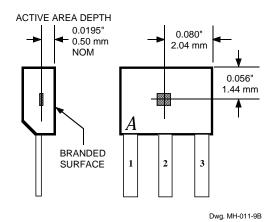


EMC test circuit

Power supply voltage transients, or device output short circuits, may be caused by faulty connectors, crimped wiring harnesses, or service errors. To prevent catastrophic failure, internal protection against overvoltage, reverse voltage, and output overloads have been incorporated to meet the automotive 12 volt system protection requirements of ISO DP7637/1. A series-blocking diode or current-limiting resistor is required in order to survive pulse number six.

SENSOR LOCATION

(±0.005" [0.13 mm] die placement)



Although sensor location is accurate to three sigma for a particular design, product improvements may result in small changes to sensor location.

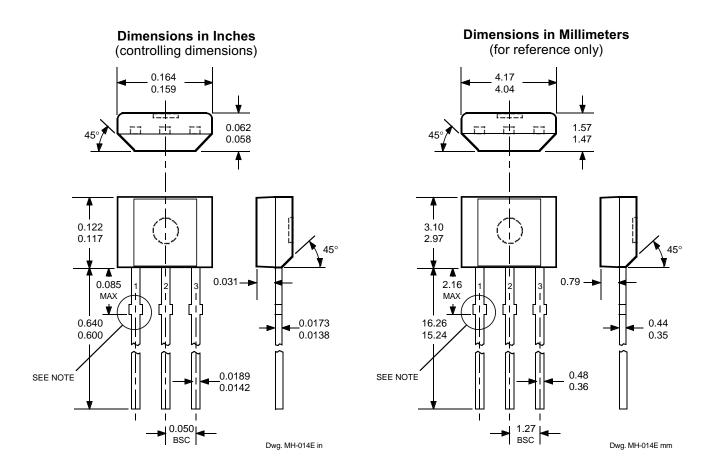
The products described herein are manufactured under one or more of the following U.S. patents: 5,045,920; 5,264,783; 5,442,283; 5,389,889; 5,581,179; 5,517,112; 5,619,137; 5,621,319; 5,650,719; 5,686,894; 5,694,038; 5,729,130; 5,917,320; and other patents pending.

Allegro MicroSystems, Inc. reserves the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the performance, reliability, or manufacturability of its products. Before placing an order, the user is cautioned to verify that the information being relied upon is current.

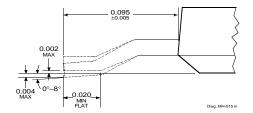
Allegro products are not authorized for use as critical components in life-support appliances, devices, or systems without express written approval.

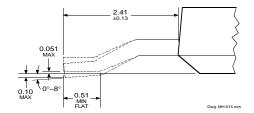
The information included herein is believed to be accurate and reliable. However, Allegro MicroSystems, Inc. assumes no responsibility for its use; nor for any infringements of patents or other rights of third parties that may result from its use.

PACKAGE DESIGNATOR 'UA'



Surface-Mount Lead Form (order A325xxUA-TL or A325xxUA-TS)





NOTES: 1. Tolerances on package height and width represent allowable mold offsets. Dimensions given are measured at the widest point (parting line).

- 2. Exact body and lead configuration at vendor's option within limits shown.
- 3. Height does not include mold gate flash.
- 4. Recommended minimum PWB hole diameter to clear transition area is 0.035" (0.89 mm).
- 5. Where no tolerance is specified, dimension is nominal.
- 6. Supplied in bulk pack (no suffix or suffix '-TL', 500 pieces per bag) or tape and reel (suffix '-TS', 4000 devices per reel).

